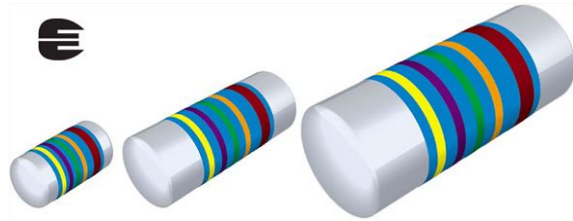


Professional Thin Film MELF Resistors



MMU 0102, MMA 0204 and MMB 0207 professional thin film MELF resistors are the perfect choice for most fields of modern professional electronics where reliability and stability is of major concern. The typical applications in the fields of automotive, telecommunication and medical equipment reflect the outstanding level of proven reliability.

FEATURES

- Approved according to EN 140401-803
- AEC-Q200 qualified
- Advanced metal film technology
- Excellent overall stability: Exceeds class 0.25
- Sulfur resistance verified according to ASTM B 809
- Material categorization:
For definitions of compliance please see www.vishay.com/doc?99912

 AUTOMOTIVE
GRADE

RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

APPLICATIONS

- Automotive
- Telecommunication
- Industrial
- Medical equipment

TECHNICAL SPECIFICATIONS			
DESCRIPTION	MMU 0102	MMA 0204	MMB 0207
DIN size	0102	0204	0207
Metric CECC size	RC 2211M	RC 3715M	RC 6123M
Resistance range	0.22 Ω to 2.21 MΩ; 0 Ω	0.22 Ω to 10 MΩ; 0 Ω	0.1 Ω to 15 MΩ; 0 Ω
Resistance tolerance	± 5 %; ± 2 %; ± 1 %; ± 0.5 %	± 5 %; ± 1 %; ± 0.5 %	± 5 %; ± 2 %; ± 1 %; ± 0.5 %
Temperature coefficient	± 50 ppm/K; ± 25 ppm/K		± 100 ppm/K; ± 50 ppm/K; ± 25 ppm/K
Rated dissipation, P_{70} ⁽¹⁾	0.3 W	0.4 W	1.0 W
Operating voltage, U_{max} . AC/DC	150 V	200 V	350 V
Operating temperature range	- 55 °C to 155 °C	- 55 °C to 155 °C	- 55 °C to 155 °C
Permissible voltage against ambient (insulation):			
1 min, U_{ins}	200 V	300 V	500 V
Continuous	75 V	75 V	75 V
Failure rate: FIT _{observed}	≤ 0.1 x 10 ⁻⁹ /h		

Note

⁽¹⁾ Please refer to APPLICATION INFORMATION below.

APPLICATION INFORMATION

The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime. At the maximum permissible film temperature of 155 °C the useful lifetime is specified for 8000 h. The designer may estimate the performance of the particular resistor application or set certain load and temperature limits in order to maintain a desired stability.



MAXIMUM RESISTANCE CHANGE AT RATED DISSIPATION			
OPERATION MODE		STANDARD	POWER
Rated dissipation, P_{70}	MMU 0102	0.2 W	0.3 W
	MMA 0204	0.25 W	0.4 W
	MMB 0207	0.4 W	1.0 W ⁽¹⁾
Operating temperature range		- 55 °C to 125 °C	- 55 °C to 155 °C
Permissible film temperature, ϑ_F max.		125 °C	155 °C
Max. resistance change at P_{70} for resistance range, $\Delta R/R$ after:	MMU 0102	0.22 Ω to 221 k Ω	0.22 Ω to 221 k Ω
	MMA 0204	0.22 Ω to 332 k Ω	0.22 Ω to 332 k Ω
	MMB 0207	0.22 Ω to 1 M Ω	0.22 Ω to 1 M Ω
	1000 h	≤ 0.15 %	≤ 0.25 %
	8000 h	≤ 0.3 %	≤ 0.5 %
	225 000 h	≤ 1.0 %	-

Note

⁽¹⁾ Specified power rating requires dedicated heat sink pads.

TEMPERATURE COEFFICIENT AND RESISTANCE RANGE				
TYPE/SIZE	TCR	TOLERANCE	RESISTANCE	E-SERIES
MMU 0102	± 50 ppm/K	± 5 %	0.22 Ω to 0.91 Ω	E24
		± 2 %	1 Ω to 9.1 Ω	
		± 1 %	10 Ω to 2.21 M Ω	E24; E96
		± 0.5 %	10 Ω to 221 k Ω	E24; E192
	± 25 ppm/K	± 1 %	10 Ω to 221 k Ω	E24; E96
		± 0.5 %	10 Ω to 221 k Ω	E24; E192
	Jumper	-	≤ 10 m Ω ; $I_{max.} = 2$ A	-
MMA 0204	± 50 ppm/K	± 5 %	0.22 Ω to 0.91 Ω	E24
		± 1 %	1 Ω to 10 M Ω	E24; E96
		± 0.5 %	10 Ω to 2.21 M Ω	E24; E192
	± 25 ppm/K	± 1 %	10 Ω to 511 k Ω	E24; E96
		± 0.5 %	10 Ω to 511 k Ω	E24; E192
	Jumper	-	≤ 10 m Ω ; $I_{max.} = 3$ A	-
MMB 0207	± 100 ppm/K	± 5 %	0.1 Ω to 0.2 Ω	E24
	± 50 ppm/K	± 5 %	0.22 Ω to 0.91 Ω	
		± 2 %	0.2 Ω to 0.91 Ω	
	± 25 ppm/K	± 1 %	1 Ω to 15 M Ω	E24; E96
		± 0.5 %	10 Ω to 1 M Ω	E24; E192
	Jumper	-	≤ 10 m Ω ; $I_{max.} = 5$ A	-



PACKAGING						
TYPE/SIZE	CODE	QUANTITY	CARRIER TAPE	WIDTH	PITCH	REEL DIAMETER
MMU 0102	B3 = BL	3000	Antistatic blister tape acc. IEC 60286-3 type II	8 mm	4 mm	180 mm/7"
	B0	10 000				330 mm/13"
	M8	8000	Bulk case acc. IEC 60286-6	-	-	-
MMA 0204	B3 = BL	3000	Antistatic blister tape acc. IEC 60286-3 type II	8 mm	4 mm	180 mm/7"
	B0	10 000				330 mm/13"
	M3	3000	Bulk case acc. IEC 60286-6	-	-	-
MMB 0207	B2	2000	Antistatic blister tape acc. IEC 60286-3 type II	12 mm	4 mm	180 mm/7"
	B7	7000				330 mm/13"

PART NUMBER AND PRODUCT DESCRIPTION																	
Part Number: MMB02070D5620DB200																	
Part Number: MMB02070Z0000ZB200																	
M	M	B	0	2	0	7	0	D	5	6	2	0	D	B	2	0	0
M	M	B	0	2	0	7	0	Z	0	0	0	0	Z	B	2	0	0
TYPE/SIZE			VERSION			TCR			RESISTANCE			TOLERANCE			PACKAGING		
MMU 0102 MMA 0204 MMB 0207			0 = EN 140401-803, "Version A"			D = ± 25 ppm/K C = ± 50 ppm/K B = ± 100 ppm/K Z = Jumper			3 digit value 1 digit multiplier			D = ± 0.5 % F = ± 1 % G = ± 2 % J = ± 5 % Z = Jumper			B3 B0 B2 B7 M3 M8		
									MULTIPLIER								
									7 = *10 ⁻³ 8 = *10 ⁻² 9 = *10 ⁻¹ 0 = *10 ⁰ 1 = *10 ¹ 2 = *10 ² 3 = *10 ³ 4 = *10 ⁴ 5 = *10 ⁵ 0000 = Jumper								
Product Description: MMB 0207-25 0.5% B2 562R																	
Product Description: MMB 0207 B2 0R0																	
MMB	0207	-25	0.5 %	B2	562R	MMB	0207	-	-	B2	0R0	MMB	0207	-25	0.5 %	B2	562R
MMA	0207	-	-	B2	0R0	MMA	0207	-	-	B2	0R0	MMA	0207	-	-	B2	0R0
TYPE	SIZE	TCR	TOLERANCE	PACKAGING	RESISTANCE	TYPE	SIZE	TCR	TOLERANCE	PACKAGING	RESISTANCE	TYPE	SIZE	TCR	TOLERANCE	PACKAGING	RESISTANCE
MMU MMA MMB	0102 0204 0207	± 25 ppm/K ± 50 ppm/K ± 100 ppm/K	± 0.5 % ± 1 % ± 2 % ± 5 %	BL B0 B2 B7 M3 M8	562R = 562 Ω 0R0 = Jumper	MMU MMA MMB	0102 0204 0207	± 25 ppm/K ± 50 ppm/K ± 100 ppm/K	± 0.5 % ± 1 % ± 2 % ± 5 %	BL B0 B2 B7 M3 M8	562R = 562 Ω 0R0 = Jumper	MMU MMA MMB	0102 0204 0207	± 25 ppm/K ± 50 ppm/K ± 100 ppm/K	± 0.5 % ± 1 % ± 2 % ± 5 %	BL B0 B2 B7 M3 M8	562R = 562 Ω 0R0 = Jumper

Note

- Products can be ordered using either the PART NUMBER or the PRODUCT DESCRIPTION.



DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade ceramic body (Al_2O_3) and conditioned to achieve the desired temperature coefficient. Nickel plated steel termination caps are firmly pressed on the metallised rods. A special laser is used to achieve the target value by smoothly cutting a helical groove in the resistive layer without damaging the ceramics. The resistor elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure tin on nickel plating. Four or five colour code rings designate the resistance value and tolerance in accordance with **IEC 60062** ⁽¹⁾.

The result of the determined production is verified by an extensive testing procedure performed on 100 % of the individual resistors. This includes full screening for the elimination of products with a potential risk of early field failures (feasible for $R \geq 10 \Omega$) according to EN 140401-803, 2.1.2.2. Only accepted products are laid directly into the blister tape in accordance with **IEC 60286-3, Type II** ⁽¹⁾ or bulk case in accordance with **IEC 60286-6** ⁽¹⁾.

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapour phase as shown in **IEC 61760-1** ⁽¹⁾. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The resistors are completely lead (Pb)-free, the pure tin plating provides compatibility with lead (Pb)-free and lead containing soldering processes. Solderability is specified for 2 years after production or requalification, however, excellent solderability is proven after extended storage in excess of 10 years. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.


All products comply with the **JIG 101** list of legal restrictions on hazardous substances.

This includes full compliance with the following directives:

- 2000/53/EC End of Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the use of Hazardous Substances Directive (RoHS)
- 2002/96/EC Waste Electrical and Electronic Equipment Directive (WEEE)

APPROVALS

The resistors are approved within the IECQ-CECC Quality Assessment System for Electronic Components to the detail specification **EN 140401-803** which refers to **EN 60115-1**, **EN 140400** and the variety of environmental test procedures of the **IEC 60068** ⁽¹⁾ series.

Conformity is attested by the use of the **CECC** logo () as the mark of conformity on the package label. Vishay Beyschlag has achieved “**Approval of Manufacturer**” in accordance with **IECQ 03-1**. The release certificate for “**Technology Approval Schedule**” in accordance with **CECC 240001** based on **IECQ 03-3-1** is granted for the Vishay Beyschlag manufacturing process.

The resistors are qualified according to AEC-Q200.

RELATED PRODUCTS

For products with precision specification see the datasheet:

- “Precision Thin Film MELF Resistors” (www.vishay.com/doc?28714)
- “Ultra Precision Thin Film MELF Resistors” (www.vishay.com/doc?28715)

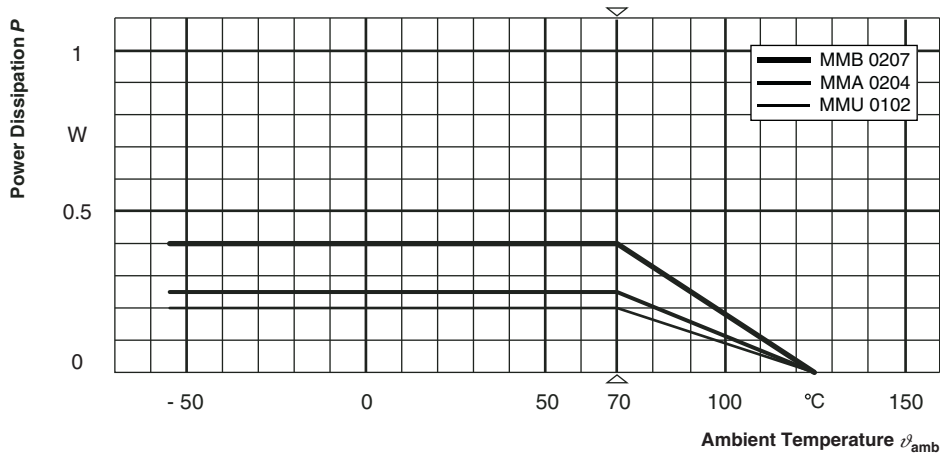
Resistors are available with established reliability in accordance with **EN 140401-803 Version E**. Please refer to datasheet “MELF Resistors with Established Reliability”. (www.vishay.com/doc?28707)

Note

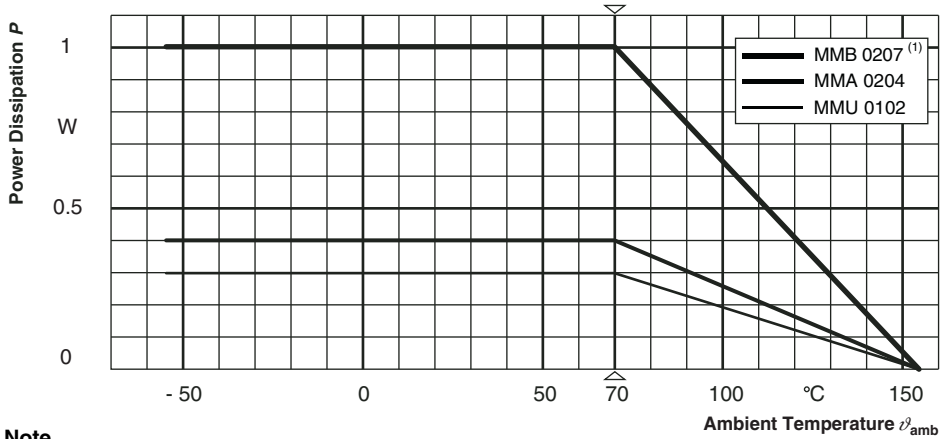
⁽¹⁾ The quoted IEC standards are also released as EN standards with the same number and identical contents.



FUNCTIONAL PERFORMANCE



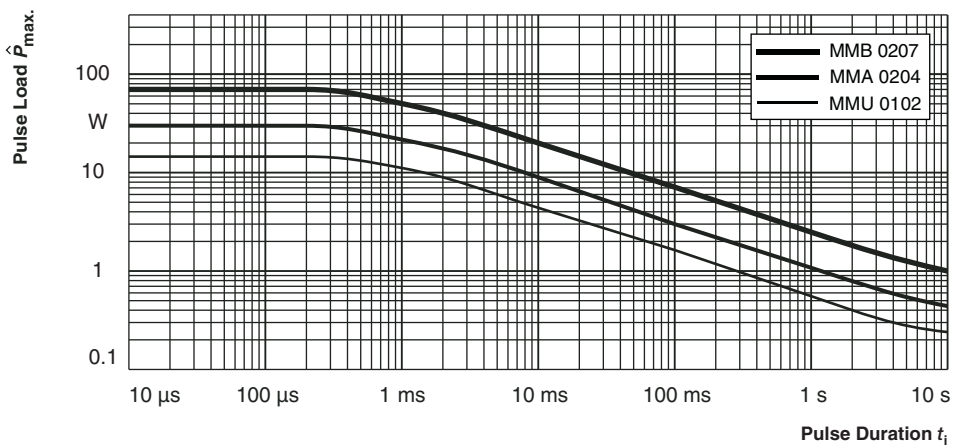
Derating - Standard Operation Mode



Note

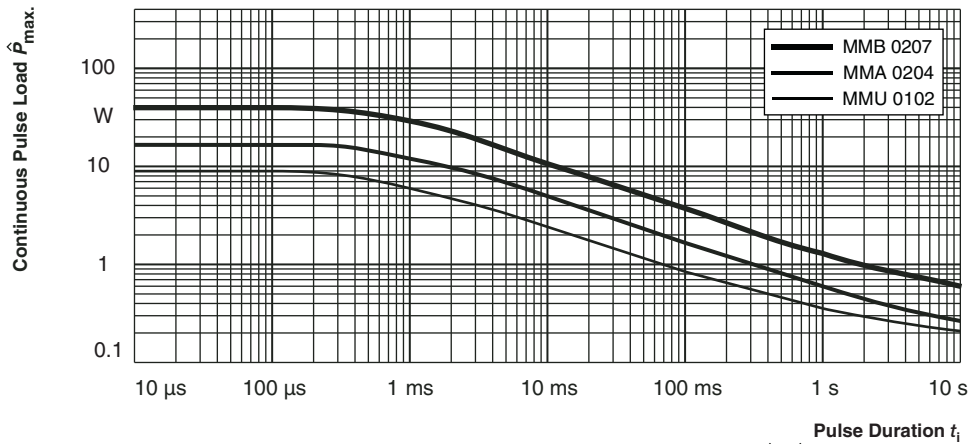
(1) Specified power rating requires dedicated heat sink pads

Derating - Power Operation Mode



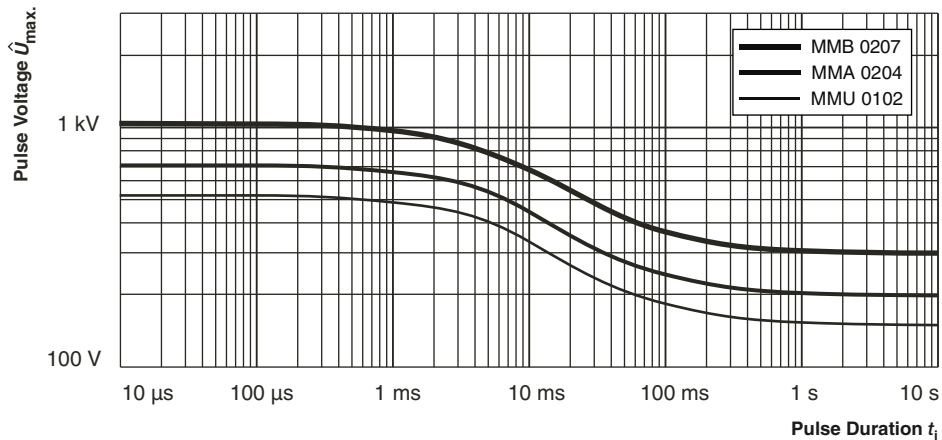
Single Pulse

Maximum pulse load, single pulse; applicable if $\bar{P} \rightarrow 0$ and $n \leq 1000$ and $\hat{U} \leq \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation in power operation mode



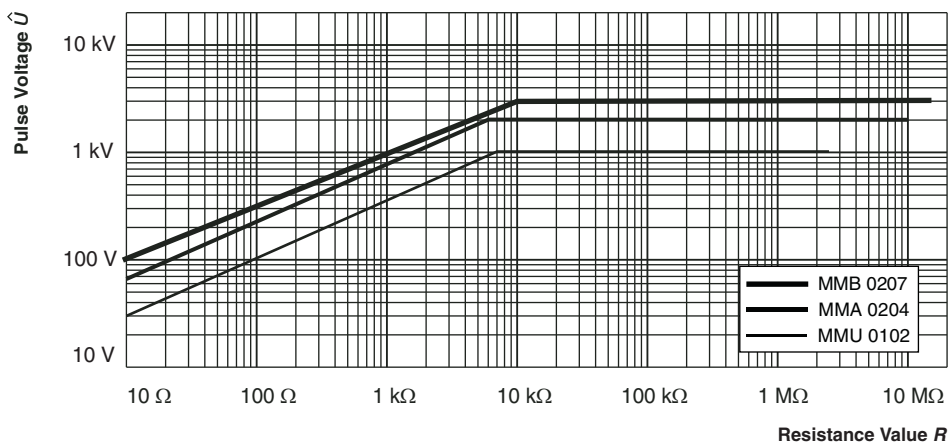
Maximum pulse load, continuous pulses; applicable if $\bar{P} \leq P(\vartheta_{amb})$ and $\hat{U} \leq \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation in power operation mode

Continuous Pulse



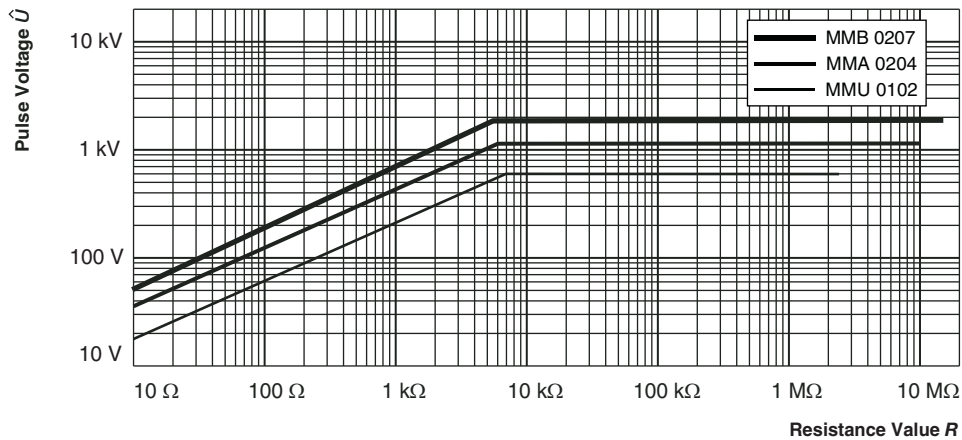
Maximum pulse voltage, single and continuous pulses; applicable if $\hat{P} \leq \hat{P}_{max}$; for permissible resistance change equivalent to 8000 h operation in power operation mode

Pulse Voltage



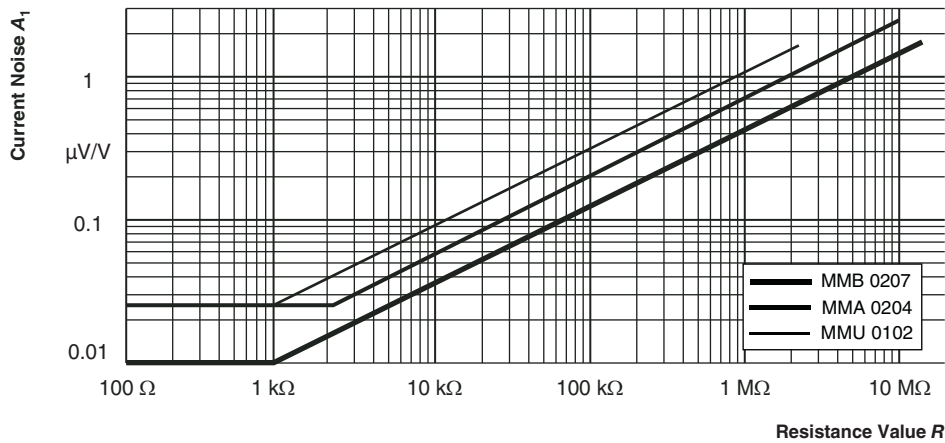
Pulse load rating in accordance with IEC 60 115-1, 4.27; 1.2 μs/50 μs; 5 pulses at 12 s intervals; for permissible resistance change (0.5 % × R + 0.05 Ω)

1.2/50 Pulse



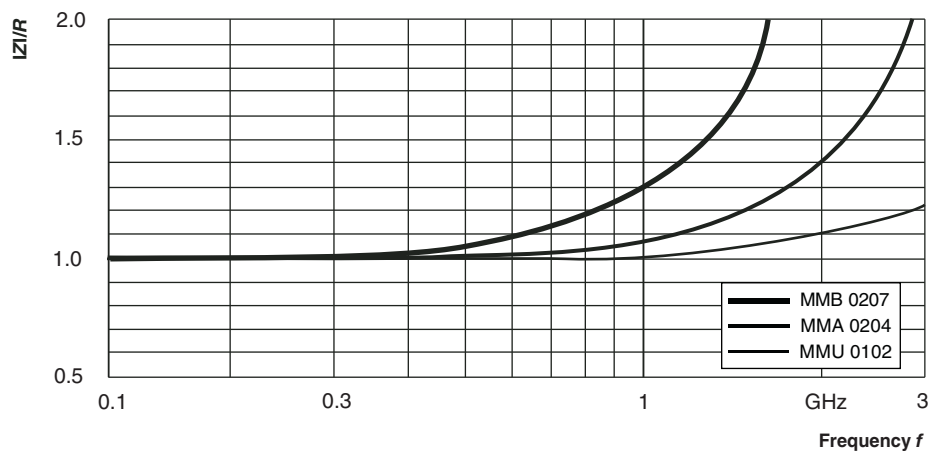
Pulse load rating in accordance with IEC 60115-1, 4.27; 10 μ s/700 μ s;
10 pulses at 1 minute intervals; for permissible resistance change (0.5 % $\times R + 0.05 \Omega$)

10/700 Pulse



Accordance with IEC 60195

Current Noise - A_1



$|Z|/R$ for 49.9 Ω MELF resistors

RF - Behaviour



TESTS AND REQUIREMENTS

All tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification (includes tests)

EN 140400, sectional specification (includes schedule for qualification approval)

EN 140401-803, detail specification (includes schedule for conformance inspection)

The components are approved in accordance with the IECQ-CECC-system, where applicable. The following table contains only the most important tests. For the full test schedule refer to the documents listed above. The testing also covers most of the requirements specified by EIA/IS 703 and JIS-C-5202.

The tests are carried out in accordance with IEC 60068 (1) and under standard atmospheric conditions in accordance with IEC 60068-1 (1), 5.3. A climatic category temperature is

applied, defined by the lower category temperature (LCT), the upper category temperature (UCT), and the number of days of the damp heat steady state test. (56).

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C

Relative humidity: 45 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

The components are mounted for testing on printed-circuit boards in accordance with EN 140400, 2.3.3, unless otherwise specified.

The requirements stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-803. However, some additional tests and a number of improvements against those minimum requirements have been included.

TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1 CLAUSE	IEC 60068-2 (1) TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)			
			Stability for product types:	STABILITY CLASS 0.25 OR BETTER	STABILITY CLASS 0.5 OR BETTER	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER
			MMU 0102	10 Ω to 221 k Ω	1 Ω to < 10 Ω	< 1 Ω	> 221 k Ω
			MMA 0204	10 Ω to 332 k Ω	1 Ω to < 10 Ω	< 1 Ω	> 332 k Ω
			MMB 0207	10 Ω to 1 M Ω	1 Ω to < 10 Ω	< 1 Ω	> 1 M Ω
4.5	-	Resistance	-	$\pm 1 \% R$; $\pm 0.5 \% R$	$\pm 2 \% R$; $\pm 1 \% R$	$\pm 5 \% R$	$\pm 1 \% R$
4.8.4.2	-	Temperature coefficient	At (20/- 55/20) °C and (20/125/20) °C	± 50 ppm/K, ± 25 ppm/K			
4.25.1	-	Endurance at 70 °C: Standard operation mode	$U = \sqrt{P_{70} \times R} \leq U_{max.}$; 1.5 h on; 0.5 h off; 70 °C; 1000 h	$\pm (0.15 \% R + 10 \text{ m}\Omega)$			$\pm (0.5 \% R + 10 \text{ m}\Omega)$ $\pm (1 \% R + 10 \text{ m}\Omega)$
			70 °C; 8000 h	$\pm (0.3 \% R + 10 \text{ m}\Omega)$			
		Endurance at 70 °C: Power operation mode	$U = \sqrt{P_{70} \times R} \leq U_{max.}$; 1.5 h on; 0.5 h off; 70 °C; 1000 h	$\pm (0.25 \% R + 10 \text{ m}\Omega)$			
			70 °C; 8000 h	$\pm (0.5 \% R + 10 \text{ m}\Omega)$			
4.25.3	-	Endurance at upper category temperature	125 °C; 1000 h	$\pm (0.15 \% R + 5 \text{ m}\Omega)$	$\pm (0.25 \% R + 5 \text{ m}\Omega)$	$\pm (0.5 \% R + 5 \text{ m}\Omega)$	$\pm (1 \% R + 5 \text{ m}\Omega)$
			155 °C; 1000 h	$\pm (0.3 \% R + 5 \text{ m}\Omega)$	$\pm (0.5 \% R + 5 \text{ m}\Omega)$	$\pm (0.1 \% R + 5 \text{ m}\Omega)$	$\pm (2 \% R + 5 \text{ m}\Omega)$
4.24	78 (Cab)	Damp heat, steady state	(40 \pm 2) °C; 56 days; (93 \pm 3) % RH	$\pm (0.15 \% R + 10 \text{ m}\Omega)$	$\pm (0.5 \% R + 10 \text{ m}\Omega)$	$\pm (0.1 \% R + 10 \text{ m}\Omega)$	$\pm (1 \% R + 10 \text{ m}\Omega)$
4.39	67 (Cy)	Damp heat, steady state, accelerated	(85 \pm 2) °C; (85 \pm 5) % RH; $U = 0.3 \times \sqrt{P_{70} \times R} \leq 100 \text{ V}$ and $U = 0.3 \times U_{max.}$; (the smaller value is valid) 1000 h	$\pm (0.25 \% R + 10 \text{ m}\Omega)$	$\pm (0.5 \% R + 10 \text{ m}\Omega)$	$\pm (1 \% R + 10 \text{ m}\Omega)$	$\pm (2 \% R + 10 \text{ m}\Omega)$



TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1 CLAUSE	IEC 60068-2 (1) TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)			
			Stability for product types:	STABILITY CLASS 0.25 OR BETTER	STABILITY CLASS 0.5 OR BETTER	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER
			MMU 0102	10 Ω to 221 k Ω	1 Ω to < 10 Ω	< 1 Ω	> 221 k Ω
			MMA 0204	10 Ω to 332 k Ω	1 Ω to < 10 Ω	< 1 Ω	> 332 k Ω
			MMB 0207	10 Ω to 1 M Ω	1 Ω to < 10 Ω	< 1 Ω	> 1 M Ω
4.23		Climatic sequence:					
4.23.2	2 (Bb)	Dry heat	UCT; 16 h				
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; 24 h; ≥ 90 % RH; 1 cycle				
4.23.4	1 (Ab)	Cold	LCT; 2 h	$\pm (0.15 \% R + 10 \text{ m}\Omega)$	$\pm (0.5 \% R + 10 \text{ m}\Omega)$	$\pm (1 \% R + 10 \text{ m}\Omega)$	$\pm (1 \% R + 10 \text{ m}\Omega)$
4.23.5	13 (M)	Low air pressure	8.5 kPa; 2 h; (25 \pm 10) °C				
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; 24 h; ≥ 90 % RH; 5 cycles				
4.23.7	-	DC load	$U = \sqrt{P_{70}} \times R \leq U_{\text{max.}}$; 1 min. LCT = - 55 °C; UCT = 155 °C				
-	1 (Ab)	Cold	- 55 °C; 2 h	$\pm (0.05 \% R + 5 \text{ m}\Omega)$			$\pm (0.1 \% R + 5 \text{ m}\Omega)$
4.19	14 (Na)	Rapid change of temperature	30 min at LCT; 30 min at UCT; LCT = - 55 °C; UCT = 125 °C 5 cycles 1000 cycles LCT = - 55 °C; UCT = 155 °C 1000 cycles		$\pm (0.05 \% R + 10 \text{ m}\Omega)$ $\pm (0.15 \% R + 10 \text{ m}\Omega)$		$\pm (0.1 \% R + 10 \text{ m}\Omega)$ $\pm (0.25 \% R + 10 \text{ m}\Omega)$ $\pm (0.5 \% R + 10 \text{ m}\Omega)$
4.13	-	Short time overload: Standard operation mode	$U = 2.5 \times \sqrt{P_{70}} \times R \leq 2 \times U_{\text{max.}}$; 5 s	$\pm (0.03 \% R + 5 \text{ m}\Omega)$			$\pm (0.15 \% R + 5 \text{ m}\Omega)$
		Short time overload: Power operation mode		$\pm (0.05 \% R + 5 \text{ m}\Omega)$			$\pm (0.15 \% R + 5 \text{ m}\Omega)$
4.27	-	Single pulse high voltage overload: Standard operation mode	Severity no. 4: $U = 10 \times \sqrt{P_{70}} \times R \leq 2 \times U_{\text{max.}}$; 10 pulses 10 μs /700 μs	$\pm (0.25 \% R + 5 \text{ m}\Omega)$			
		Single pulse high voltage overload: Power operation mode		$\pm (0.5 \% R + 5 \text{ m}\Omega)$			



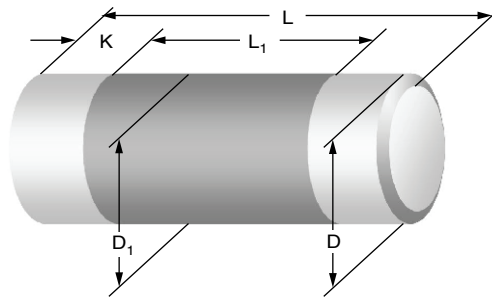
TEST PROCEDURES AND REQUIREMENTS							
EN 60115-1 CLAUSE	IEC 60068-2 (1) TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)			
			Stability for product types:	STABILITY CLASS 0.25 OR BETTER	STABILITY CLASS 0.5 OR BETTER	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER
			MMU 0102	10 Ω to 221 k Ω	1 Ω to < 10 Ω	< 1 Ω	> 221 k Ω
			MMA 0204	10 Ω to 332 k Ω	1 Ω to < 10 Ω	< 1 Ω	> 332 k Ω
			MMB 0207	10 Ω to 1 M Ω	1 Ω to < 10 Ω	< 1 Ω	> 1 M Ω
4.37	-	Periodic electric overload: Standard operation mode	$U = \sqrt{15 \times P_{70} \times R} \leq 2 \times U_{max}$ 0.1 s on; 2.5 s off; 1000 cycles	$\pm (0.5 \% R + 5 \text{ m}\Omega)$			
		Periodic electric overload: Power operation mode		$\pm (1 \% R + 5 \text{ m}\Omega)$			
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude $\leq 1.5 \text{ mm}$ or $\leq 200 \text{ m/s}^2$; 7.5 h	$\pm (0.05 \% R + 5 \text{ m}\Omega)$			$\pm (0.1 \% R + 5 \text{ m}\Omega)$
4.40	-	Electrostatic discharge (Human Body Model)	IEC 61340-3-1 (1); 3 pos. + 3 neg. discharges MMU 0102: 1.5 kV MMA 0204: 2 kV MMB 0207: 4 kV	$\pm (0.5 \% R + 0.05 \Omega)$			
4.17.2	58 (Td)	Solderability	Solder bath method; SnPb40; non-activated flux; (215 \pm 3) $^{\circ}\text{C}$; (3 \pm 0.3) s	Good tinning ($\geq 95 \%$ covered); no visible damage			
			Solder bath method; SnAg3Cu0.5 or SnAg3.5; non-activated flux; (235 \pm 3) $^{\circ}\text{C}$; (2 \pm 0.2) s	Good tinning ($\geq 95 \%$ covered); no visible damage			
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method; (260 \pm 5) $^{\circ}\text{C}$; (10 \pm 1) s	$\pm (0.05 \% R + 10 \text{ m}\Omega)$	$\pm (0.1 \% R + 10 \text{ m}\Omega)$	$\pm (0.25 \% R + 10 \text{ m}\Omega)$	$\pm (0.25 \% R + 10 \text{ m}\Omega)$
			Reflow method 2 (IR/forced gas convection); (260 \pm 5) $^{\circ}\text{C}$; (10 \pm 1) s	$\pm (0.02 \% R + 10 \text{ m}\Omega)$	$\pm (0.05 \% R + 10 \text{ m}\Omega)$	$\pm (0.05 \% R + 10 \text{ m}\Omega)$	$\pm (0.1 \% R + 10 \text{ m}\Omega)$
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 $^{\circ}\text{C}$; method 2	No visible damage			
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 $^{\circ}\text{C}$; method 1, toothbrush	Marking legible; no visible damage			
4.32	21 (Ue ₃)	Shear (adhesion)	45 N	No visible damage			
4.33	21 (Ue ₁)	Substrate bending	Depth 2 mm, 3 times	No visible damage, no open circuit in bent position $\pm (0.05 \% R + 5 \text{ m}\Omega)$ (2)			
4.7	-	Voltage proof	$U_{RMS} = U_{ins}$; 60 s	No flashover or breakdown			
4.35	-	Flammability	IEC 60695-11-5 (1); needle flame test; 10 s	No burning after 30 s			

Notes

(1) The quoted IEC standards are also released as EN standards with the same number and identical contents.

(2) Special requirements apply to MICRO-MELF, MMU 0102:

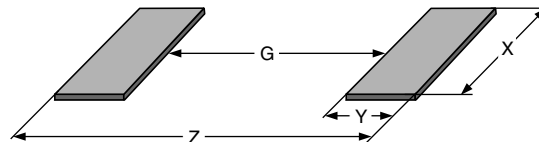
- $R < 100 \Omega$: $\pm (0.25 \% R + 10 \text{ m}\Omega)$
- $100 \Omega \leq R \leq 221 \text{ k}\Omega$: $\pm 0.1 \% R$
- $221 \text{ k}\Omega < R$: $\pm 0.25 \% R$

DIMENSIONS


DIMENSIONS AND MASS						
TYPE/SIZE	L (mm)	D (mm)	L ₁ min. (mm)	D ₁ (mm)	K (mm)	MASS (mg)
MMU 0102	2.2 + 0/- 0.1	1.1 + 0/- 0.1	1.2	D + 0/- 0.1	0.4 ± 0.05	8
MMA 0204	3.6 + 0/- 0.2	1.4 + 0/- 0.1	1.8	D + 0/- 0.15	0.8 ± 0.1	22
MMB 0207	5.8 + 0/- 0.15	2.2 + 0/- 0.2	3.2	D + 0/- 0.2	1.25 ± 0.1	80

Note

- Color code marking is applied according to IEC 60062 ⁽¹⁾ in four bands (E24 series) or five bands (E96 or E192 series). Each color band appears as a single solid line, voids are permissible if at least $\frac{2}{3}$ of the band is visible from each radial angle of view. The last color band for tolerance is approximately 50 % wider than the other bands. An interrupted yellow band between the 4th and 5th full band indicates TC25.

PATTERN STYLES FOR MELF RESISTORS


RECOMMENDED SOLDER PAD DIMENSIONS								
TYPE/SIZE	WAVE SOLDERING				REFLOW SOLDERING			
	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)
MMU 0102	0.7	1.2	1.5	3.1	1.1	0.8	1.3	2.7
MMA 0204	1.5	1.5	1.8	4.5	1.7	1.2	1.6	4.1
MMB 0207	2.8	2.1	2.6	7.0	3.2	1.7	2.4	6.6

Notes

- The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly. Specified power rating above 125 °C requires dedicated heat-sink pads, which to a great extent depend on board materials and design. The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g. in standards IEC 61188-5-x ⁽¹⁾, or in publication IPC-7351. They do not guarantee any supposed thermal properties, particularly as these are also strongly influenced by many other parameters.

Still, the given solder pad dimensions will be found adequate for most general applications, e.g. those referring to “standard operation mode”. Please note however that applications for “power operation mode” require special considerations for the design of solder pads and adjacent conductor areas.

⁽¹⁾ The quoted IEC standards are also released as EN standards with the same number and identical contents.



HISTORICAL 12NC INFORMATION

- The resistors had a 12-digit numeric code starting with 2312.
- The subsequent 4 digits indicated the resistor type, specification and packaging; see the 12NC table.
- The remaining 4 digits indicated the resistance value:
 - The first 3 digits indicated the resistance value.
 - The last digit indicated the resistance decade in accordance with the 12NC Indicating Resistance Decade table.

Last Digit of 12NC Indicating Resistance Decade

RESISTANCE DECADE	LAST DIGIT
0.1 Ω to 0.999 Ω	7
1 Ω to 9.99 Ω	8
10 Ω to 99.9 Ω	9
100 Ω to 999.9 Ω	1
1 kΩ to 9.99 kΩ	2
10 kΩ to 99.9 kΩ	3
100 kΩ to 999 kΩ	4
1 MΩ to 9.99 MΩ	5
10 MΩ to 99.9 MΩ	6

Historical 12NC

The 12NC of a MMU 0102 resistor, value 47 kΩ. and TCR 50 with ± 1 % tolerance, supplied in blister tape of 3000 units per reel is: 2312 165 14703.

HISTORICAL 12NC - Resistor type and packaging						
DESCRIPTION			2312			
			BLISTER TAPE ON REEL		BULK CASE	
TYPE	TCR	TOL.	BL 3000 UNITS	B0 10 000 UNITS	M8 8000 UNITS	
MMU 0102	± 50 ppm/K	± 5 %	165 3....	175 3....	060 3....	
		± 2 %	165 2....	175 2....	060 2....	
		± 1 %	165 1....	175 1....	060 1....	
		± 0.5 %	165 5....	175 5....	060 5....	
	± 25 ppm/K	± 1 %	166 1....	176 1....	061 1....	
		± 0.5 %	166 5....	176 5....	061 5....	
	Jumper			165 90001	175 90001	060 90001
TYPE	TCR	TOL.	B2 3000 UNITS	B7 10 000 UNITS	M3 3000 UNITS	
MMA 0204	± 50 ppm/K	± 5 %	155 3....	145 3....	040 3....	
		± 1 %	155 1....	145 1....	040 1....	
		± 0.5 %	155 5....	145 5....	040 5....	
	± 25 ppm/K	± 1 %	156 1....	146 1....	041 1....	
		± 0.5 %	156 5....	146 5....	041 5....	
	Jumper			155 90001	145 90001	040 90001
	MMB 0207	± 100 ppm/K	± 5 %	195 3....	185 3....	
± 50 ppm/K		± 5 %	195 3....	185 3....		
		± 2 %	195 2....	185 2....		
		± 1 %	195 1....	185 1....		
± 25 ppm/K		± 0.5 %	196 5....	186 5....		
Jumper			195 90001	185 90001		



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